



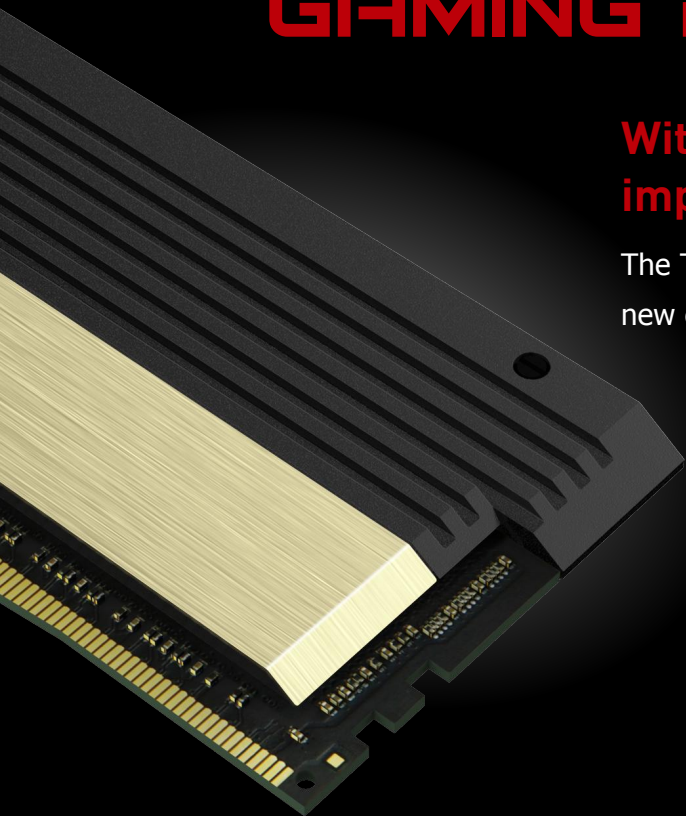
DDR4 GAMING XTREEM

T-Force | DDR4 Xtream

T-FORCE GAMING DDR4 XTREEM

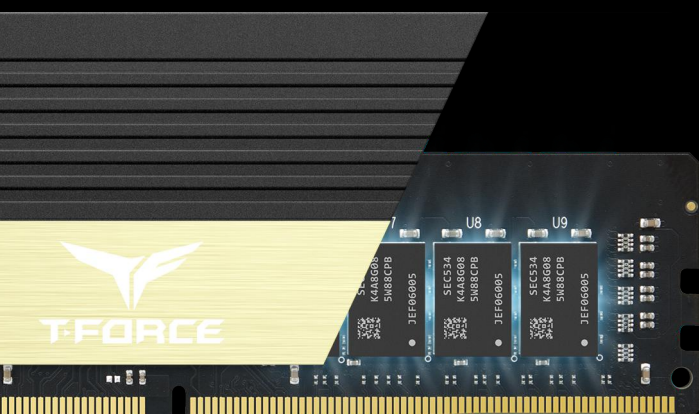
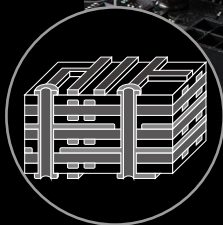
With unique trench design and improve radiating performance **10%**

The Team Group design team had built a heat spreader with an all new exterior design concept. The overclocking memory module with highest specification is built by top notch aluminum extrusion process and CNC machining. The unique trench design can increase the radiating area to improve radiating efficiency. XTREEM combines simple and magnificent design with its top specification overclocking memory module. The clean, sleek lines are able to magnify its high speed specification.



10 layers of circuit board largely improves stability

The number of PCB layers is 25% more than normal memories. This provides better efficiency and performance since the power layer and the signal layer has a farther distance between each other. Without the interference between the power and the signal, it can offer players the overclocking pleasure and a high stability overclocking memory module.



Selected high quality SAMSUNG original IC chips

Team Group insists on using high quality SAMSUNG original IC chips and passed through various rigorous internal tests. Its high reliability makes players feel at ease.

Ultra low working voltage Save energy up to 40%

With low working voltage 1.2~1.4V from DDR4 XTREEM , it is not only energy saving but it can also reduce the temperature and the heat generated to offer the high speed running memory a stable and long time operation.



XMP2.0 1 step overclocking technology

All XTREEM series support Intel XMP 2.0. It is only one step away to experience the high speed sensation of overclocking.





QVL approved by motherboard manufacturers

Multiple compatibility verifications with mainstream DDR4 motherboards to make sure its stability with all motherboards on the QVL(Qualified Vendor List). Therefore, you wouldn't have to worry about compatibility issues when purchasing high speed memory.

Main Feature

- The finest crafted heat spreader with unique trench design
- High-efficiency aluminum heat spreader
- 10 layers of circuit board
- Selected high quality SAMSUNG original IC chips
- 1.2V~1.4V ultra low working voltage
- Support Intel XMP 2.0 smart overclocking technology
- QVL approved by motherboard manufactures in the market



Specification

Item	Specification				
Module Type	288 Pin Unbuffered DIMM Non ECC				
Capacity	4GBx2 / 8GBx2			8GBx2	
Frequency	3466	3600	3733	3866	4000
Data transfer bandwidth	27,728 MB/s (PC4 27700)	28,800 MB/s (PC4 28800)	29,864 MB/s (PC4 29800)	30,928 MB/s (PC4 30900)	32,000 MB/s (PC4 32000)
CL-Value	CL17-19-19-39	CL17-19-19-39 CL18-20-20-39	CL17-19-19-39 CL18-20-20-39	CL18-20-20-39 CL18-20-20-44	CL18-20-20-44
Voltage	1.2V				
Heat Sink	Aluminum heat-sink				
Operation System	Desktop or notebook computer with DDR4 Memory Slots Required OS: Windows 10 / 8.1 / 8 / 7 / Vista / XP				
Warranty	Lifetime Warranty				

Ordering Information

Description	Color	Timings/Voltage	Capacity	Team P/N
TEAM Xtream UD-D4 3466	Silver	CL17-19-19-39 1.35V	4GBx2	TXD48G3466HC17ADC01
		CL17-19-19-39 1.35V	8GBx2	TXD416G3466HC17ADC01
TEAM Xtream UD-D4 3600		CL17-19-19-39 1.35V	4GBx2	TXD48G3600HC17ADC01
		CL18-20-20-39 1.35V	8GBx2	TXD416G3600HC18ADC01
TEAM Xtream UD-D4 3733		CL17-19-19-39 1.35V	4GBx2	TXD48G3733HC17ADC01
		CL18-20-20-39 1.35V	8GBx2	TXD416G3733HC18ADC01
TEAM Xtream UD-D4 3866		CL18-20-20-39 1.35V	4GBx2	TXD48G3866HC18ADC01
		CL18-20-20-44 1.35V	8GBX2	TXD416G3866HC18EDC01
TEAM Xtream UD-D4 4000		CL18-20-20-44 1.35V	8GBX2	TXD416G4000HC18EDC01
TEAM Xtream UD-D4 3466		Gold	CL17-19-19-39 1.35V	4GBx2
	CL17-19-19-39 1.35V		8GBx2	TXGD416G3466HC17ADC01
TEAM Xtream UD-D4 3600	CL17-19-19-39 1.35V		4GBx2	TXGD48G3600HC17ADC01
	CL18-20-20-39 1.35V		8GBx2	TXGD416G3600HC18ADC01
TEAM Xtream UD-D4 3733	CL17-19-19-39 1.35V		4GBx2	TXGD48G3733HC17ADC01
	CL18-20-20-39 1.35V		8GBx2	TXGD416G3733HC18ADC01
TEAM Xtream UD-D4 3866	CL18-20-20-39 1.35V		4GBx2	TXGD48G3866HC18ADC01
	CL18-20-20-44 1.35V		8GBX2	TXGD416G3866HC18EDC01
TEAM Xtream UD-D4 4000	CL18-20-20-44 1.35V		8GBX2	TXGD416G4000HC18EDC01

Above technical information is based on industry standard data and tested to be reliable. However, Team makes no warranty, either expressed or implied, as to its accuracy and assumes no liability in connection with the use of this product.

Team reserves the right to make changes in specifications at any time without prior notice.